MINIATURE RELAY 2-CONTACT 1A (FOR SWITCHING SIGNALS)

FTR-B3 SERIES

RoHS Compliant

FEATURES

- These are flat type ultra miniature (SMT), 5.2±0.2mm height (through hole) relays for telecommunication and data networking equipments, made of high heat resistant material, which can support IRS and VPS methods.
- Ultra slim and light weight with a 5.25±0.2 mm height and approximately 0.8 g weight, and an 87mm² mounting area. Most suitable for decreasing size and weight, space saving and high density packaging of equipment.
- Contact spring has superb high frequency characteristics.
- High insulation design conforming to the Bellcore, FCC standard, with a minimum of 1.6 mm between coil and contacts insulation distance, an AC 1.5kV coil contact withstand voltage, and a 2.5kV coil-contact withstand surge voltage.
- High efficieny polar electromagnet structure implements a140mW low coil power consumption. A power saving latch type is also available.
- Gold-plated silver alloy bifurcated contacts having high contact reliability.
- UL, CSA recognized. Confirms to IEC 60950, UL1950, EN60950. Spacing & high breakdown voltage (Basic insulation, 150 working volts, pollution degree 2).
- RoHS compliant since date code: 0431B8 Please see page 10 for more information



ORDERING INFORMATION

FTR-B3 G B 012 Z -B 10 [Example] (b) (c) (d) (a) (e) (f) (g) Series Name FTR-B3 Series (a) C: through hole G: surface mount (b) Terminal type S: mounting area, reduced SMT A: standard type **Operation function** (c) B: latching type (1 coil) 1.5: 1.5VDC 4.5: 4.5VDC 12VDC 3VDC (d) Rated voltage of coil 003: 012: 024: 24VDC Contact material Z: gold overlay silver alloy (e) (f) Relay enclosing direction* B: standard enclosing direction (g) Number of relays per reel* 10: 1,000 (standard)

Remarks: Actual marking on relay would not carry code FTR and be as below:Ordering codeActual markingFTR-B3GA012Z-B10 \rightarrow B3GA012Z

Note: *:

- Only surface mount types (G and S) are applicable

- All relays are packaged in tubes unles P/N ends with -B10

■ SAFETY STANDARD AND FILE NUMBERS

UL508, 1950 (File No. E63615) C22.2 No. 14, No. 950 (File No. LR40304) Please request when the approval markings are required on the cover.

Nominal voltage	Contact rating		
1.5 to 12 VDC	0.5 A 125 VAC		

■ COIL DATA CHART

Standard type

MODEL	Rated coil voltage	Coil resistance (±10%)	Operating voltage	Release voltage*	Rated power consumption
FTR-B3()A1.5Z	1.5VDC	16.1 Ω	+1.13V	+0.15V	140mW
FTR-B3()A003Z	3VDC	64.3 Ω	+2.25V	+0.3V	140mW
FTR-B3()A4.5Z	4.5VDC	145 Ω	+3.38V	+0.45V	140mW
FTR-B3()A012Z	12VDC	1,028 Ω	+9.0V	+1.2V	140mW
FTR-B3()A024Z	24VDC	2,504 Ω	+18.0V	+2.4V	230mW

* Pulse driven

Note: All values in the table are measured at 20°C.

Latching type (1 coil)

	Rated coil voltage	Coil resistance (±10%)	Set voltage	Release voltage*	Rated power consumption
FTR-B3 ()B1.5Z	1.5VDC	22.5 Ω	+1.13V	-1.13V	100mW
FTR-B3 ()B003Z	3VDC	90 Ω	+2.25V	-2.25V	100mW
FTR-B3 ()B4.5Z	4.5VDC	203 Ω	+3.38V	-3.38V	100mW
FTR-B3 ()B012Z	12VDC	1,440 Ω	+9.0V	-9.0V	100mW
FTR-B3 ()B024Z	24VDC	4,800 Ω	+18.0V	-18.0V	120mW

* Pulse driven

Note: All values in the table are measured at 20°C.

■ SPECIFICATIONS

Item			Standard Type	Latching Type	
		FTR-B3 () A	FTR-B3 () B		
Arrangement		2Form C			
			Gold overlay silver alloy		
			Bifurcated contacts (cross-bar)		
	Contact res	sistance (initial value)	$75 \mathrm{m}\Omega$, maximum at 6VDC 1A		
	Contact rat	ing	30VDC 1A, 125VAC 0.3A (resistive)		
Contact	Maximum o	carrying/switching current	1A		
	Maximum switching power		62.5 VA / 30W		
	Maximum switching voltage		250 VAC, 220 VDC		
	Minimum s	witching load *1	10mVDC, 0.01mA*1		
(Capacitance		Approximately 0.4pF (between open contacts) Approimately 0.5pF (adjacent contacts) Approximately 1.0pF *1(between coil and contacts)		
	Nominal po	ower (at 20°C)	140mW	100mW	
Coil	Operate po	ower (at 20°C)	80mW	57mW	
	Operating temperature (no frost)		-40° C to +85° C		
Time	Time Operate (at nominal voltage, without bounce)		3ms maximum		
Value	Release (at nominal voltage, without bounce)		3ms maximum		
	Resistance (at 500VDC)		Minimum 1,000 M χχ		
		between open contacts	1,000 VAC 1 minute		
Insulation	Dielectric Strength	between adjacent contacts	1,000 VAC 1 minute		
		between coil and contacts	1,500 VAC 1 minute		
	Surge Strength	between open contacts	1,500V (at 10 x 160µs) [FCC Part 68]		
		between adjacent contacts	1,500V (at 10 x 160µs) [FCC Part 68]		
		between coil and contacts	1,500V (at 10 x 160μs) [FCC Part 68] 2,500V (at 2 x 10μs) [Bellcore]		

*1 Minimum switching loads mentioned above are reference values. Please perform the confirmation test with the actual load before production since reference values may vary according to switching frequencies, environmental conditions and expected reliability levels.

continued

SPECIFICATIONS

continued

Item		Standard Type	Latching Type		
		FTR-B3 () A	FTR-B3 () B		
Mechanical		50 x 10° operations min. (at 3Hz)	20 x 10 ⁶ operations min.(at3Hz)		
Life	Electrical (resistive load)		100 x 10 ³ operations min. at 1A 30VDC (at 0.5Hz) 100 x 10 ³ operations min. at 0.3A 125VDC (at 0.5Hz)		
Vibration	Vibration	Malfunction	10 to 55 Hz at double amplitude of 3.3mm		
	resistance	Endurance	10 to 55 Hz at double amp	litude of 5mm	
Other	Shock	Malfunction	Min. 750 m/s ²		
r	resistance	Endurance	Min. 1000 m/s ²		
Weight		Approximately 0.8g			

CHARACTERISTIC DATA



continued

CHARACTERISTIC DATA

continued





Life Curve

REFERENCE DATA









Nominal Voltage Multiplying Factor (%)

Distribution of Contact Resistance



Distribution of Operate and Release Time



Mechanical Life Test



continued

■ SPECIFICATIONS

continued



(Coil side indication)

Unit: mm

■ DIMENSIONS

FTR-B3G()()()



FTR-B3S()()()





T₃ = 200°C maximum Temperature T₂ = 165°C maximum T₁ = 100°C maximum preheating T₁ 0 30 sec Max. 0 120 sec maximum 60 sec Max. 60 sec Max. 90 sec Max.

Note: 1.Temperature profiles show the temperature of PC board surface. 2. Please perform soldering test with your actual PC board before mass production, since the temperatures of PC board surfaces vary according to the size of PC board, status of parts mounting and heating method.

PRECAUTIONS

- For details on general precautions, refer to the section on technical descriptions.

- Since this is a polar relay, follow the instructions of the internal wiring diagram for the +- connections of the coil.
- Note that the terminal array and internal wiring of the surface mount relay are a top view

RoHS Compliance and Lead Free Relay Information 1. General Information

- Relays produced after the specific date code that is indicated on each data sheet are lead-free now. Most of our signal and power relays are lead-free. Please refer to Lead-Free Status Info. (http://www.fcai.fujitsu.com/pdf/LeadFreeLetter.pdf)
- Lead free solder paste currently used in relays is Sn-3.0Ag-0.5Cu. From February 2005 forward Sn-3.0Cu-Ni will be used for FTRB3 and FTR-B4 series relays.
- Most signal and some power relays also comply with RoHS. Please refer to individual data sheets. Relays that are RoHS compliant do not contain the 6 hazardous materials that are restricted by RoHS directive (lead, mercury, cadmium, chromium IV, PBB, PBDE).
- It has been verified that using lead-free relays in leaded assembly process will not cause any problems (compatible).
- "LF" is marked on each outer and inner carton. (No marking on individual relays).
- To avoid leaded relays (for lead-free sample, etc.) please consult with area sales office.

We will ship leaded relays as long as the leaded relay inventory exists.

2. Recommended Lead Free Solder Profile

• Recommended solder paste Sn-3.0Ag-0.5Cu and Sn-3.0 Cu-Ni (only FTR-B3 and FTR-B4 from February 2005) **Reflow Solder condtion**



We highly recommend that you confirm your actual solder conditions

3. Moisture Sensitivity

• Moisture Sensitivity Level standard is not applicable to electromechanical realys.

4. Tin Whisker

• SnAgCu solder is known as low riskof tin whisker. No considerable length whisker was found by our in-house test.

5. Solid State Relays

• Each lead terminal will be changed from solder plating to Sn plating and Nickel plating. A layer of Nickel plating is between the terminal and the Sn plating to avoid whisker.

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